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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of:

Docket No.: TI-33887

Christo P. Bojkov, et al.

Art Unit: TBD

Serial No: 10/086,117

Filed: 2/26/02

For: Waferlevel Method for Direct Bumping on Copper Pads in Integrated Circuits

Assistant Commissioner for

Patents

Washington, DC 20231

MAILING CERTIFICATE UNDER 37 C.F.R. §1.8(A)

I hereby certify that the above correspondence is being deposited with the U.S. Postal Service on 6-5-02 as First Class Mail in an envelope addressed to: Assistant Commissioner for Patents, Washington, D C

Karen Vertz
Karen Vertz

6-5-02
Date

RESPONSE TO NOTICE TO FILE MISSING PARTS OF APPLICATION

Dear Sir:

In response to the Notice of Missing Parts dated May 24, 2002 please charge the fee of \$130.00 for the surcharge under 37 CFR 1.27 to Deposit Account No. 20-0668 of Texas Instruments Incorporated.

Please find enclosed the Declaration/Power of Attorney (1 page), an Assignment with Form PTO 1595 and formal drawings for the above-referenced case. The Commissioner is hereby authorized to charge any additional fees which may be required. **This sheet is submitted in triplicate.**

Respectfully submitted,

Gary C. Honeycutt
Gary C. Honeycutt
Attorney for Applicants
Reg. No. 20,250

Texas Instruments Incorporated
Mail Station 3999
P.O. Box 655474
Dallas, TX 75265
(214) 939-8651

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COPY OF PAPERS
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Applicant(s): Christo P. Bojkov, et al.

Art Unit: TBD

Serial No.: 10/086,117

Examiner: TBD

Filed: 02/26/02

Docket: TI-33887

For: Waferlevel Method for Direct Bumping on Copper Pads in Integrated Circuits

LETTER TO THE OFFICIAL DRAFTSPERSON

MAILING CERTIFICATE UNDER 37 C.F.R. §1.8(A)

I hereby certify that the above correspondence is being deposited with the U.S. Postal Service on 6-5-02 as First Class Mail in an envelope addressed to Assistant Commissioner for Patents, Washington, D.C. 20231

Karen Vertz
Karen Vertz

6-5-02
Date

Assistant Commissioner for
Patents
Washington, D. C. 20231

Dear Sir:

Enclosed are **THREE (3)** sheets of formal drawings for the above-referenced case. Please charge any necessary fees to Deposit Account No. 20-0668 of Texas Instruments Incorporated. This sheet is enclosed in triplicate.

Texas Instruments Incorporated
P.O. Box 655474 M/S 3999
Dallas, Texas 75265
(214) 939-8651

Respectfully submitted,

Gary C. Honeycutt
Gary C. Honeycutt
Reg. No. 20,250
Attorney for Applicants

10086117-061402



UNITED STATES PATENT AND TRADEMARK OFFICE

COMMISSIONER FOR PATENTS
UNITED STATES PATENT AND TRADEMARK OFFICE
WASHINGTON, D.C. 20231
www.uspto.gov

APPLICATION NUMBER	FILING/RECEIPT DATE	FIRST NAMED APPLICANT	ATTORNEY DOCKET NUMBER
10/086.117	02/26/2002	Christo P. Bojkov	TI-33887

CONFIRMATION NO. 2251

23494
TEXAS INSTRUMENTS INCORPORATED
P O BOX 655474, M/S 3999
DALLAS, TX 75265

FORMALITIES LETTER



OC000000008187342

Date Mailed: 05/24/2002

NOTICE TO FILE MISSING PARTS OF NONPROVISIONAL APPLICATION

FILED UNDER 37 CFR 1.53(b)

Filing Date Granted

Items Required To Avoid Abandonment:

An application number and filing date have been accorded to this application. The item(s) indicated below, however, are missing. Applicant is given **TWO MONTHS** from the date of this Notice within which to file all required items and pay any fees required below to avoid abandonment. Extensions of time may be obtained by filing a petition accompanied by the extension fee under the provisions of 37 CFR 1.136(a).

- The oath or declaration is unsigned.
- To avoid abandonment, a late filing fee or oath or declaration surcharge as set forth in 37 CFR 1.16(l) of \$130 for a non-small entity, must be submitted with the missing items identified in this letter.

The application is informal since it does not comply with the regulations for the reason(s) indicated below.

The required item(s) identified below must be timely submitted to avoid abandonment:

- Substitute drawings in compliance with 37 CFR 1.84 because:
 - drawing sheets do not have the appropriate margin(s) (see 37 CFR 1.84(g)). Each sheet must include a top margin of at least 2.5 cm. (1 inch), a left side margin of at least 2.5 cm. (1 inch), a right side margin of at least 1.5 cm. (5/8 inch), and a bottom margin of at least 1.0 cm. (3/8 inch);

Items Required To Avoid Processing Delays:

The item(s) indicated below are also required and should be submitted with any reply to this notice to avoid further processing delays.

SUMMARY OF FEES DUE:

Total additional fee(s) required for this application is \$130 for a Large Entity

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- \$130 Late oath or declaration Surcharge

A copy of this notice MUST be returned with the reply.

Thmiquach

Customer Service Center

Initial Patent Examination Division (703) 308-1202

PART 2 - COPY TO BE RETURNED WITH RESPONSE

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2017-07-27